

100V N-Channel Enhancement Mode MOSFET

Voltage 100 V Current 2.5 A

Features

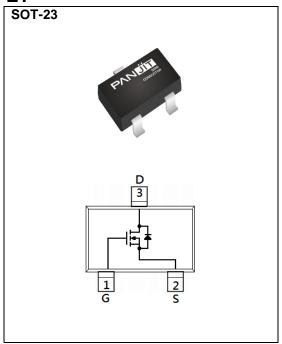
- RDS(ON), VGS@10V, ID@2A<118m Ω
- RDS(ON), VGS@4.5V, ID@1A<160m Ω
- Excellent FOM
- Logic Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: SOT-23 Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.0084 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	±20		
Continuous Drain Current(Note 3)	T _A =25°C	l _D	2.5		
	T _A =70°C		2.1	Α	
Pulsed Drain Current(Note 1)	T _A =25°C	I _{DM}	10		
Power Dissipation	T _A =25°C	D-	1.5	W	
	T _A =70°C	Pb	1.05		
Operating Junction and Storage Temperature Range		T_{J} , T_{STG}	-55~175	°C	
Thermal Resistance(Note 3,4)	Junction to Ambient	R _{θJA}	100	°C/W	



Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	100	-	-		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1.2	1.8	3	V	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =2A	-	94	118	mΩ	
		V _{GS} =4.5V, I _D =1A	-	123	160		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V	-	-	1	uA	
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA	
Dynamic ^(Note 5)							
Total Gate Charge	Q_g	V _{DS} =50V, I _D =2A,	-	4.4	-		
Gate-Source Charge	Q_{gs}		-	0.94	-	nC	
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	0.97	-		
Input Capacitance	Ciss	V _{DS} =50V, V _{GS} =0V,	-	155	-	pF	
Output Capacitance	Coss		-	28	-		
Reverse Transfer Capacitance	Crss	f=1MHz	-	11	-		
Gate resistance	Rg	f=1MHz	-	2	-	Ω	
Turn-On Delay Time	td _(on)	V _{DS} =50V, I _D =2A,	-	2.9	-		
Turn-On Rise Time	tr		-	2	-		
Turn-Off Delay Time	td _(off)	$V_{GS}=10V, R_{G}=3\Omega$ (Note 2)	-	7.6	-	ns	
Turn-Off Fall Time	tf	(Note 2)	-	11.4	-		
Drain-Source Diode							
Diode Forward Current	Is	T 05°0	-	-	2.5	A	
Pulsed Diode Forward Current	I _{SM}	T _C =25°C	-	-	10		
Diode Forward Voltage	V _{SD}	I _S =2A, V _{GS} =0V	-	0.8	1.3	V	
Reverse Recovery Time	Trr	V _{GS} =0V, I _S =2A	-	23	-	ns	
Reverse Recovery Charge	Qrr	dls/dt=100A/us	-	13	-	nC	

NOTES:

- 1. Pulse width<300us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an $R_{\theta JA}=100^{\circ}C/W$.
- 4. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 5. Guaranteed by design, not subject to production testing.



TYPICAL CHARACTERISTIC CURVES

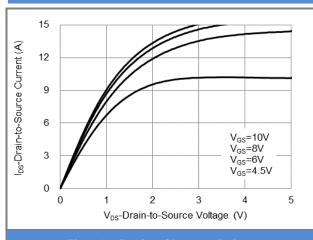


Fig.1 On-Region Characteristics

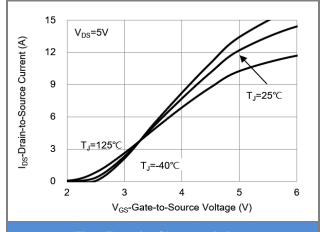


Fig.2 Transfer Characteristics

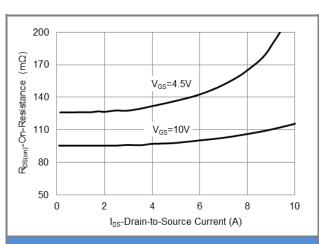


Fig.3 On-Resistance vs. Drain Current

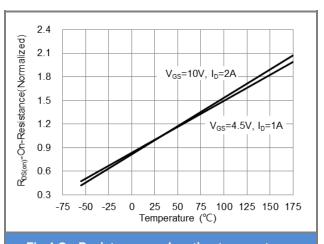
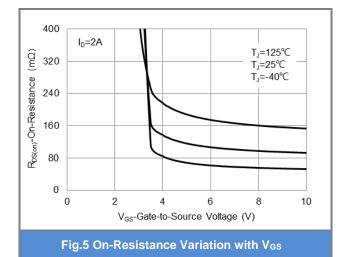
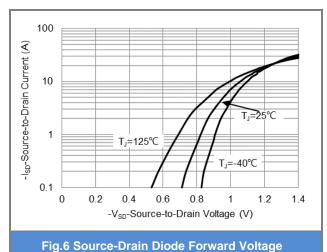


Fig.4 On-Resistance vs. Junction temperature







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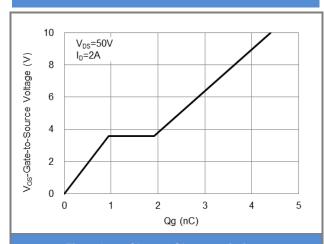


Fig.7 Gate-Charge Characteristics

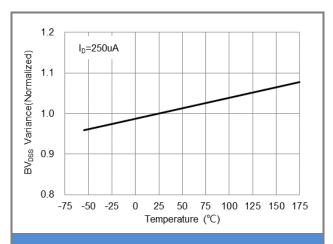


Fig.8 Breakdown Voltage Variation vs. Temperature

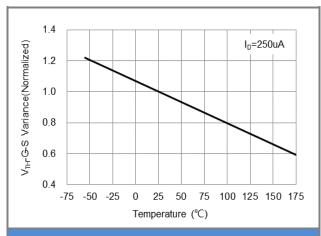


Fig.9 Threshold Voltage Variation with Temperature

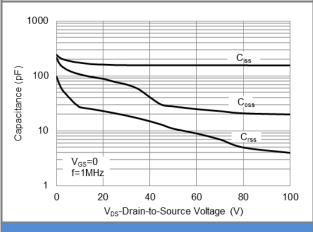
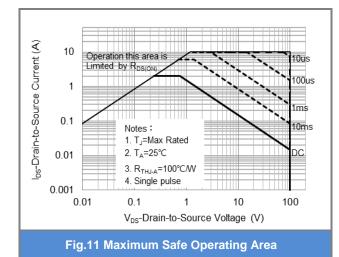


Fig.10 Capacitance vs. Drain-Source Voltage



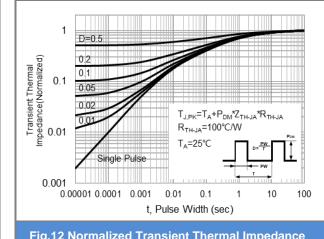


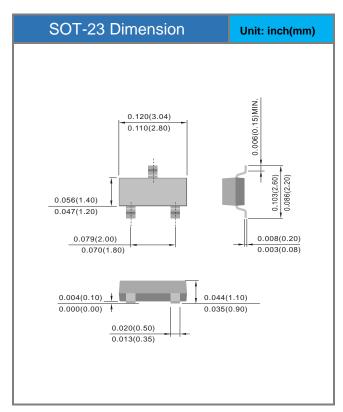
Fig.12 Normalized Transient Thermal Impedance

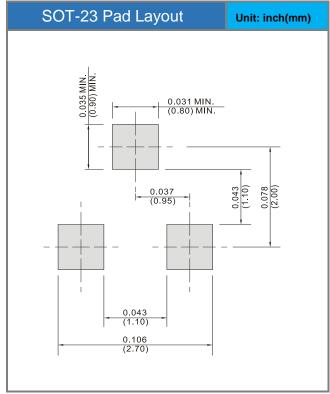


Product and Packing Information

Part No.	Package Type	Packing Type	Marking	
PJA3474S-AU	SOT-23	3K pcs / 7" reel	A78	

Packaging Information & Mounting Pad Layout







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